



FRU Programmer for FPGA Mezzanine Cards (FMC)

FMC single width

[x] Low-pin count

[] High-pin count

[x] Carrier card

[] Mezzanine card

Layer	Name	Material	Thickness	Constant	Board Layer Stack
	Top Overlay				
	Top Solder	Solder Resist	0,010mm	3,5	
1	Top Layer	Copper	0,036mm		
	Dielectric 1	FR-4	1,509mm	4,2	
2	Bottom Layer	Copper	0,036mm		
	Bottom Solder	Solder Resist	0,010mm	3,5	
	Bottom Overlay				

Total board thickness:

1,600mm